



SamHop Microelectronics Corp.



STU405DH

Nov,20 2007 ver1.0

Dual Enhancement Mode Field Effect Transistor (N and P Channel)

PRODUCT SUMMARY (N-Channel)		
V _{DSS}	I _D	R _{D(S(ON))} (mΩ) Max
40V	11A	33 @ V _{GS} = 10V
		45 @ V _{GS} = 4.5V

PRODUCT SUMMARY (P-Channel)		
V _{DSS}	I _D	R _{D(S(ON))} (mΩ) Max
-40V	- 9A	45 @ V _{GS} = -10V
		65 @ V _{GS} = -4.5V



ABSOLUTE MAXIMUM RATINGS (T_A=25°C unless otherwise noted)

Parameter	Symbol	N-Channel	P-Channel	Unit
Drain-Source Voltage	V _{DS}	40	-40	V
Gate-Source Voltage	V _{GS}	±20	±20	V
Drain Current-Continuous @ T _c	25°C	I _D	11	A
	70°C		9	A
-Pulsed ^a	I _{DM}	45	-36	A
Drain-Source Diode Forward Current	I _S	7	-6	A
Maximum Power Dissipation	T _c =25°C	P _D	11	W
	T _c =70°C		7.7	
Operating Junction and Storage Temperature Range	T _J , T _{STG}	-55 to 175		°C

THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Case	R _{θJC}	13.6	°C/W
Thermal Resistance, Junction-to-Ambient	R _{θJA}	120	°C/W

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N-Channel ELECTRICAL CHARACTERISTICS (TA = 25 °C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ ^c	Max	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BVDSS	V _{GS} =0V, I _D =250uA	40			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =32V, V _{GS} =0V			1	uA
Gate-Body Leakage	I _{GSS}	V _{GS} =±20V, V _{DS} =0V			±100	nA
ON CHARACTERISTICS ^a						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250uA	1	1.5	3	V
Drain-Source On-State Resistance	R _{D(S(ON))}	V _{GS} =10V, I _D =8A		24	33	m ohm
		V _{GS} =4.5V, I _D =6A		30	45	m ohm
On-State Drain Current	I _{D(ON)}	V _{DS} =5V, V _{GS} =4.5V	20			A
Forward Transconductance	g _{FS}	V _{DS} =10V, I _D =8A		13.8		S
DYNAMIC CHARACTERISTICS ^b						
Input Capacitance	C _{ISS}	V _{DS} =25V, V _{GS} =0V f=1.0MHz		580		pF
Output Capacitance	C _{OSS}			82		pF
Reverse Transfer Capacitance	C _{RSS}			50		pF
SWITCHING CHARACTERISTICS ^b						
Turn-On Delay Time	t _{D(ON)}	V _{DD} =20V I _D =1 A V _{GS} =10V R _{GEN} =3.3 ohm		11		ns
Rise Time	t _r			10.2		ns
Turn-Off Delay Time	t _{D(OFF)}			17.3		ns
Fall Time	t _f			20		ns
Total Gate Charge	Q _g	V _{DS} =28V, I _D =8A, V _{GS} =10V		11.3		nC
		V _{DS} =28V, I _D =8A, V _{GS} =4.5V		5.8		nC
Gate-Source Charge	Q _{gs}	V _{DS} =28V, I _D =8 A V _{GS} =10V		1.2		nC
Gate-Drain Charge	Q _{gd}			2.9		nC

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P-Channel ELECTRICAL CHARACTERISTICS (TA = 25 °C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ ^c	Max	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BVDSS	V _{GS} =0V, I _D =-250uA	-40			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-32V, V _{GS} =0V			-1	uA
Gate-Body Leakage	I _{GSS}	V _{GS} =±20V, V _{DS} =0V			±100	nA
ON CHARACTERISTICS ^a						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250uA	-1	-1.7	-3	V
Drain-Source On-State Resistance	R _{D(S(ON))}	V _{GS} =-10V, I _D = -6A		35	45	m ohm
		V _{GS} =-4.5V, I _D = -4A		52	65	m ohm
On-State Drain Current	I _{D(ON)}	V _{DS} = -5V, V _{GS} = -10V	-20			A
Forward Transconductance	g _{FS}	V _{DS} = -10V, I _D =-6A		12		S
DYNAMIC CHARACTERISTICS ^b						
Input Capacitance	C _{ISS}	V _{DS} = -25V, V _{GS} = 0V f = 1.0MHz		980		pF
Output Capacitance	C _{OSS}			135		pF
Reverse Transfer Capacitance	C _{RSS}			90		pF
SWITCHING CHARACTERISTICS ^b						
Turn-On Delay Time	t _{D(ON)}	V _{DD} = -20V I _D = -1A V _{GS} = -10V R _{GEN} = 3.3 ohm		12		ns
Rise Time	t _r			17		ns
Turn-Off Delay Time	t _{D(OFF)}			82		ns
Fall Time	t _f			35		ns
Total Gate Charge	Q _g	V _{DS} = -28V, I _D = -6A, V _{GS} = -10V		20.7		nC
		V _{DS} = -28V, I _D = -6A, V _{GS} = -4.5V		11		nC
Gate-Source Charge	Q _{gs}	V _{DS} = -28V, I _D = -6 A V _{GS} = -10V		1.5		nC
Gate-Drain Charge	Q _{gd}			6.2		nC

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ELECTRICAL CHARACTERISTICS ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ ^c	Max	Unit
DRAIN-SOURCE DIODE CHARACTERISTICS ^b						
Diode Forward Voltage	V_{SD}	$V_{GS} = 0\text{V}, I_S = 7\text{A}$ $V_{GS} = 0\text{V}, I_S = -6\text{A}$	N-Ch P-Ch	0.98 -0.9	1.2 -1.2	V

Notes

a. Pulse Test: Pulse Width $\leq 300 \mu\text{s}$, Duty Cycle $\leq 2\%$.

b. Guaranteed by design, not subject to production testing.

N-Channel

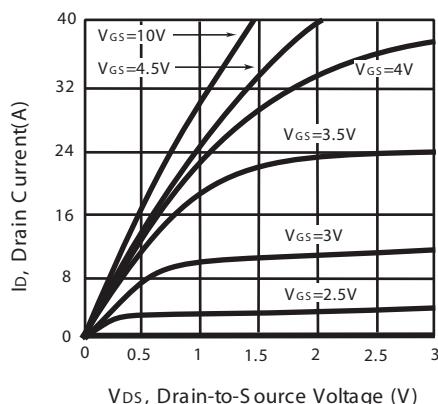


Figure 1. Output Characteristics

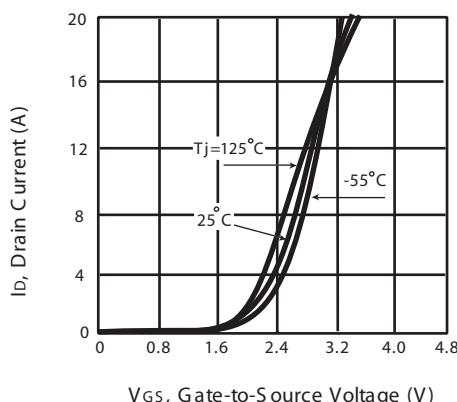


Figure 2. Transfer Characteristics

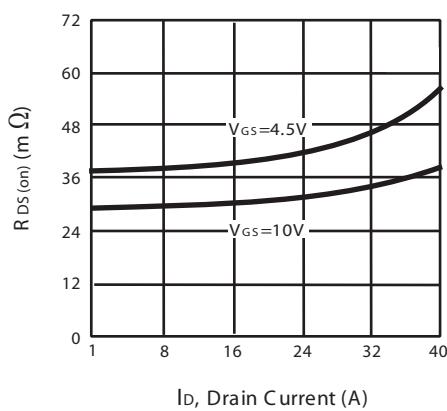


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

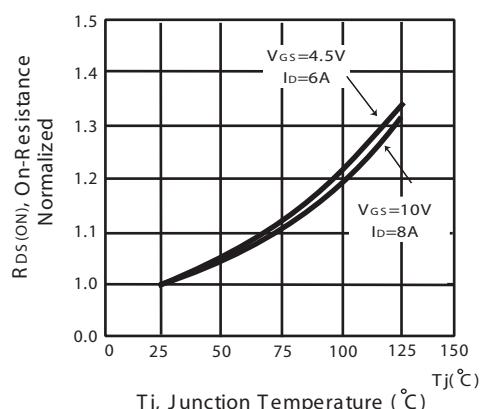


Figure 4. On-Resistance Variation with Drain Current and Temperature

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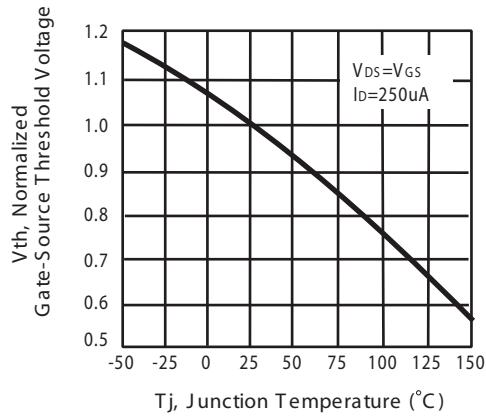


Figure 5. Gate Threshold Variation with Temperature

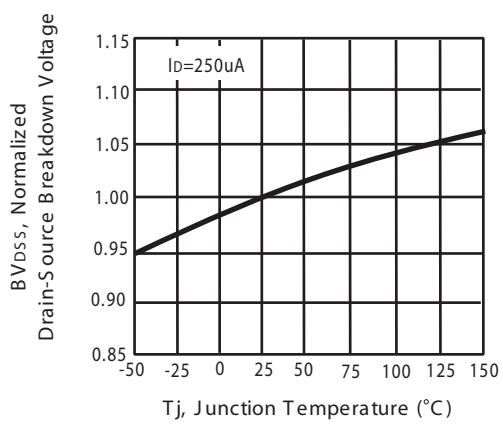


Figure 6. Breakdown Voltage Variation with Temperature

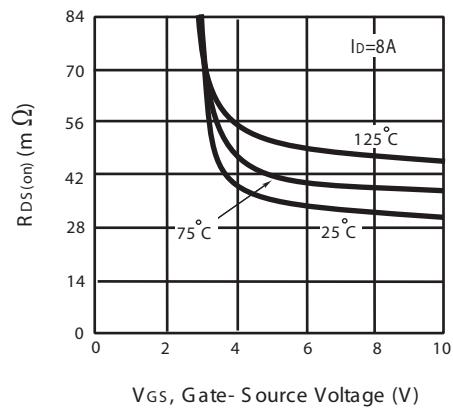


Figure 7. On-Resistance vs. Gate-Source Voltage

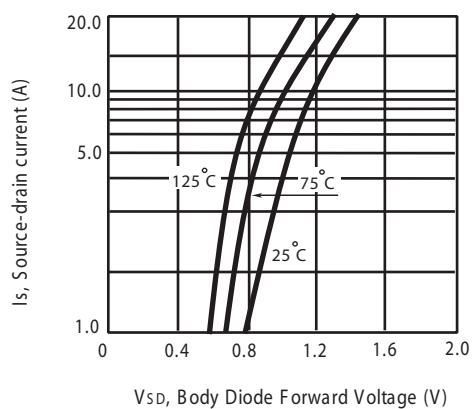


Figure 8. Body Diode Forward Voltage Variation with Source Current

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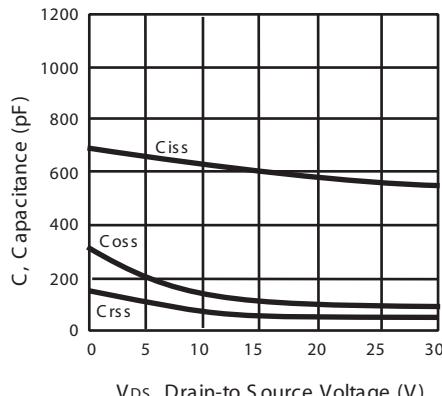


Figure 10. Capacitance

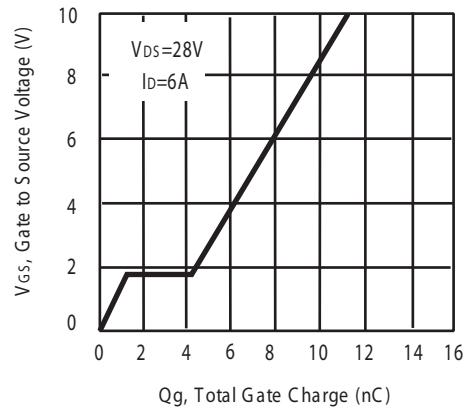


Figure 11. Gate Charge

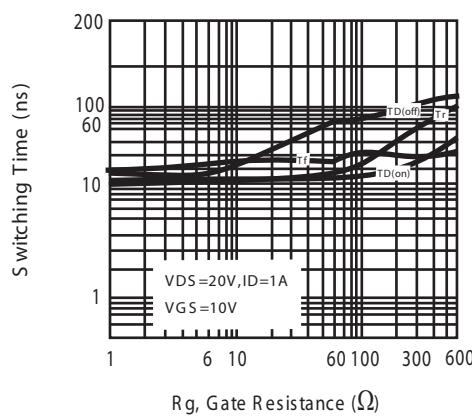


Figure 12. switching characteristics

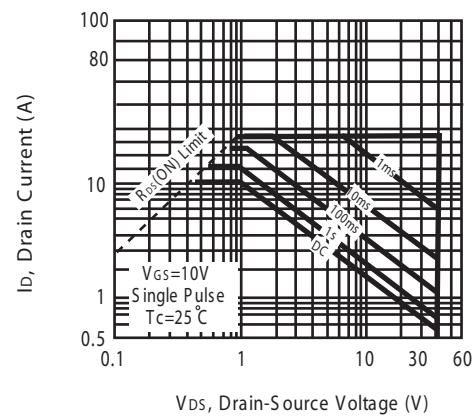


Figure 13. Maximum Safe Operating Area

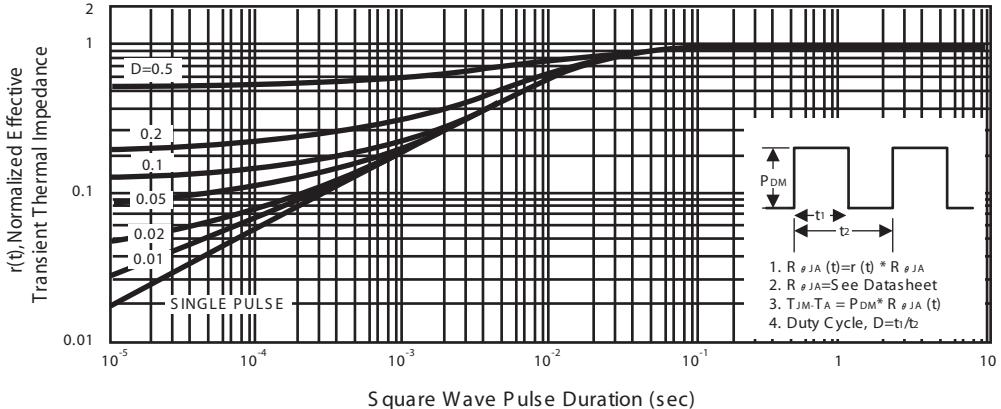


Figure 14. Normalized Thermal Transient Impedance Curve

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P-Channel

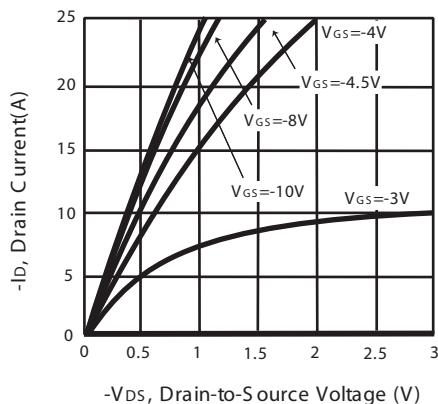


Figure 1. Output Characteristics

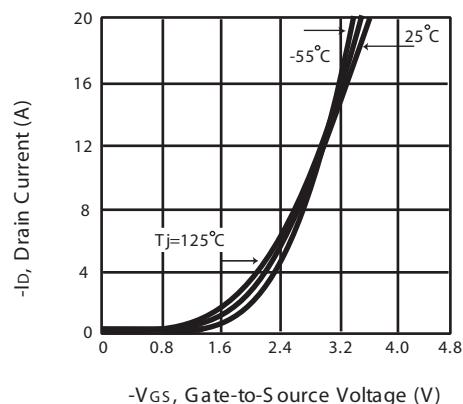


Figure 2. Transfer Characteristics

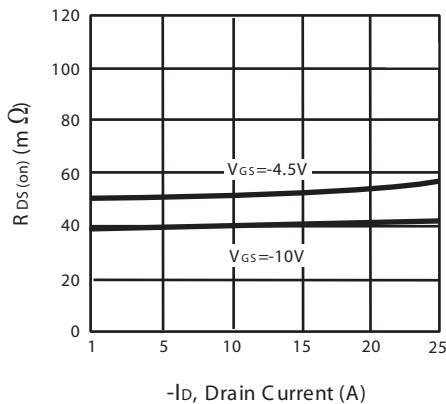


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

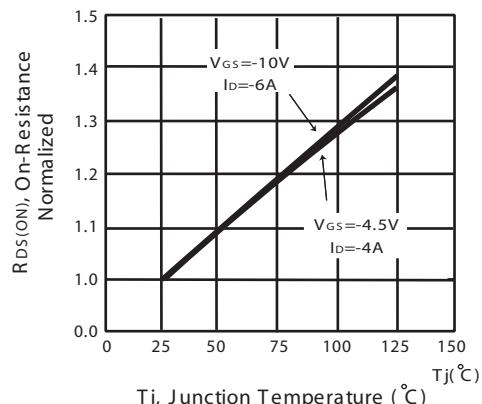


Figure 4. On-Resistance Variation with Drain Current and Temperature

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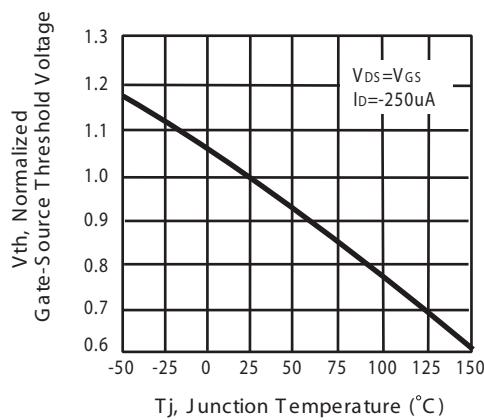


Figure 5. Gate Threshold Variation with Temperature

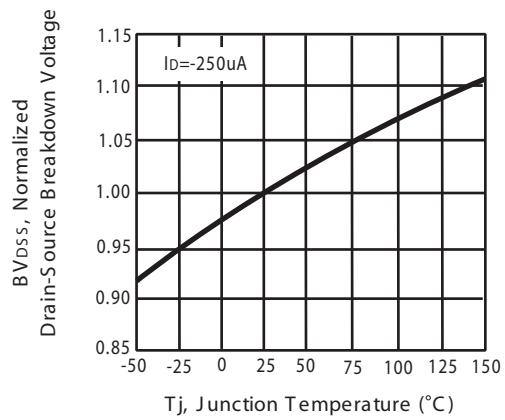


Figure 6. Breakdown Voltage Variation with Temperature

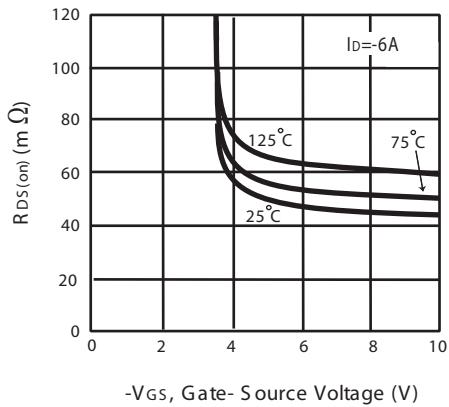


Figure 7. On-Resistance vs. Gate-Source Voltage

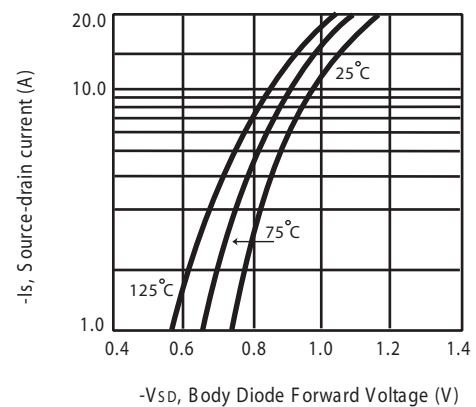


Figure 8. Body Diode Forward Voltage Variation with Source Current

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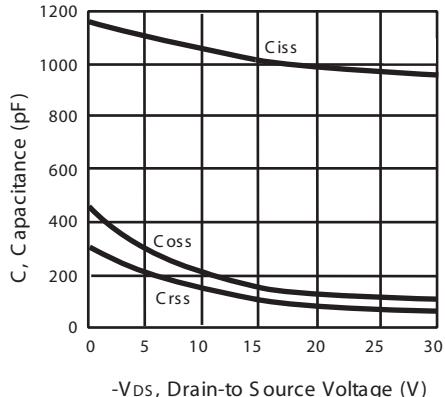


Figure 9. Capacitance

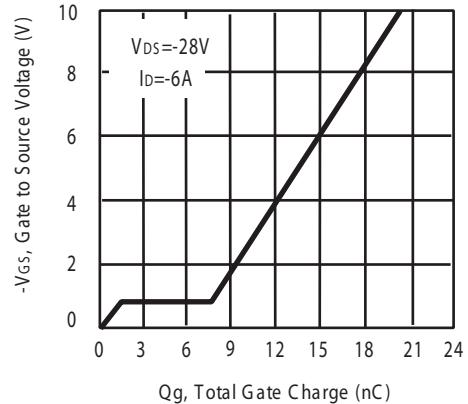


Figure 10. Gate Charge

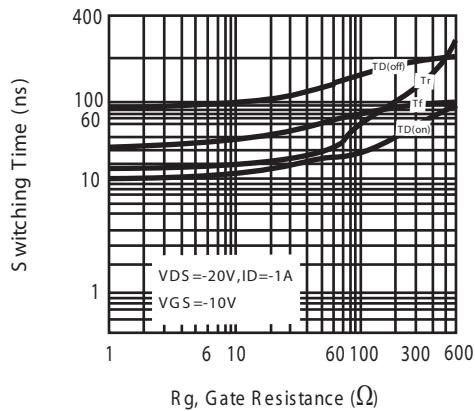


Figure 11. switching characteristics

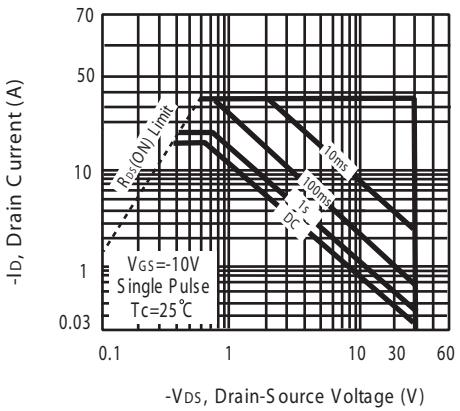


Figure 12. Maximum Safe Operating Area

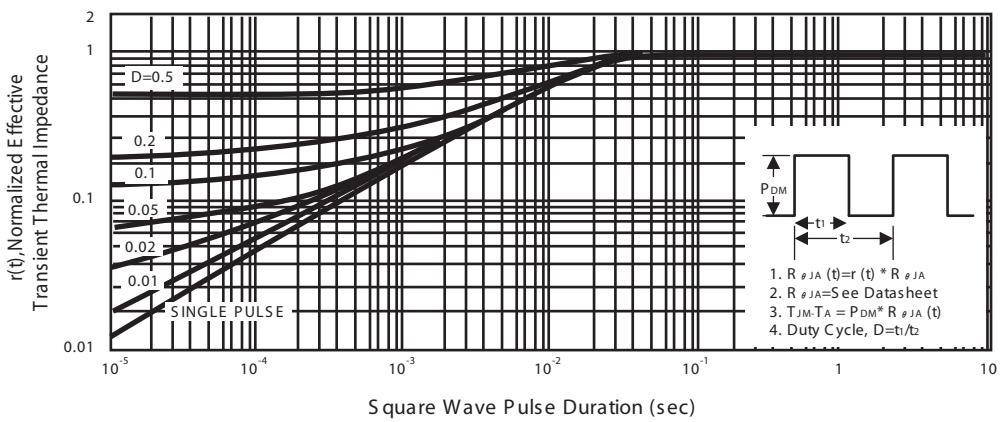
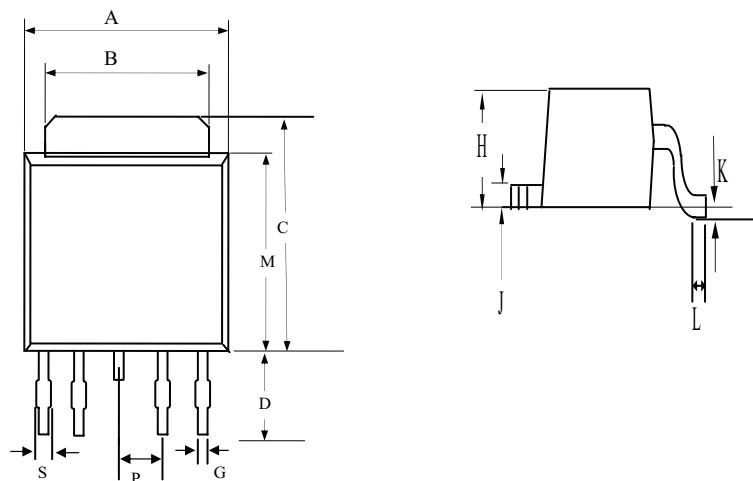


Figure 13. Normalized Thermal Transient Impedance Curve

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PACKAGE OUTLINE DIMENSIONS

TO-252-4L

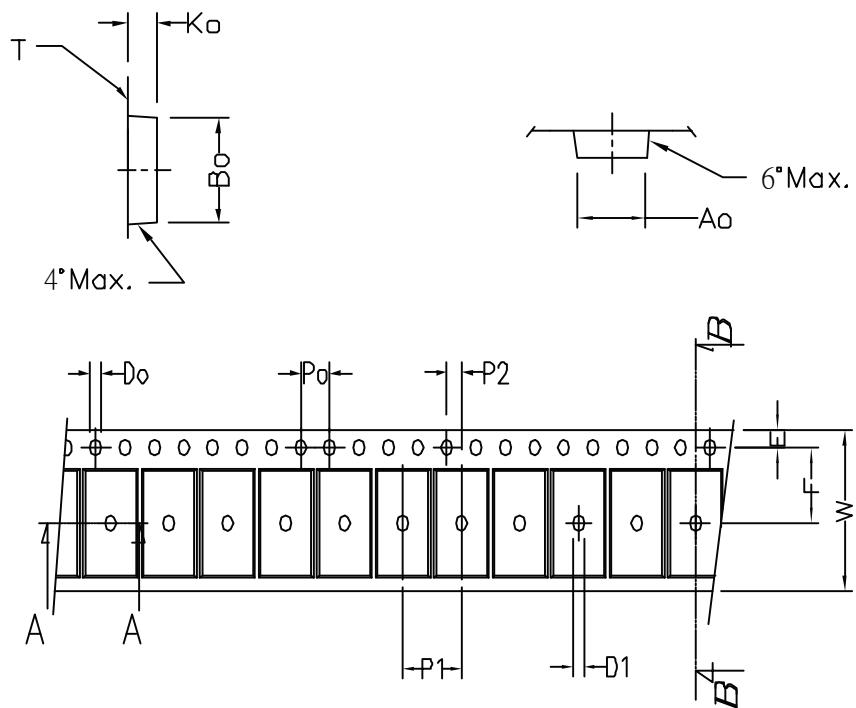


REF.	Millimeters	
	MIN	MAX
A	6.40	6.80
B	5.2	5.50
C	6.80	10.20
D	2.20	3.00
P	1.27 REF.	
S	0.50	0.80
G	0.40	0.60
H	2.20	2.40
J	0.45	0.60
K	0	0.15
L	0.90	1.50
M	5.40	5.80

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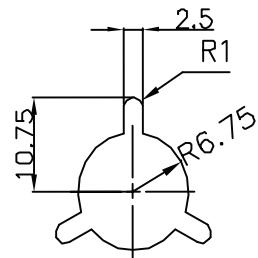
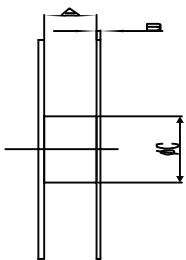
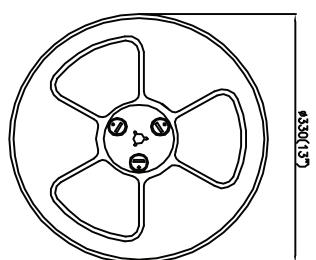
TO-252-5L Tape and Reel Data

TO-252-5L Carrier Tape



symbol	Ao	Bo	Ko	Po	P1	P2	T
Spec	6.96 ± 0.1	10.49 ± 0.1	2.79 ± 0.1	4.0 ± 0.1	8.0 ± 0.10	2.0 ± 0.05	0.33 ± 0.013
symbol	E	F	Do	D1	W	10Po	
Spec	1.75 ± 0.1	7.5 ± 0.05	1.55 ± 0.05	1.5 ± 0.25	16.0 ± 0.3	40.0 ± 0.2	

TO-252-5L Reel



UNIT:mm

Width of carrier tape	8	12	16	24	32	44	56
$A \pm 0.1$	9.4	13.4	17.4	25.4	33.4	45.4	57.4
B	2.3	2.3	2.3	2.3	2.3	2.3	2.3
ϕC	100	100	100	100	100	100	100